

## SERIES 2000 ANTENNAS

Check for Samples: [RI-ANT-G01E](#), [RI-ANT-G02E](#), [RI-ANT-S01C](#), [RI-ANT-S02C](#)

### FEATURES

- **Best in Class Performance Through Patented HDX Technology**
- **Protection Class IP 65 and Higher**
- **Four Form Factors Available**
- **Proven in Harsh Industrial Environments**
- **Easy to Install and Use**

### APPLICATIONS

- **Access Control**
- **Vehicle Identification**
- **Container Tracking**
- **Asset Management**
- **Waste Management**

### DESCRIPTION

These antenna products connect to radio frequency modules (RFM) and reader/writers to form the interface to the low-frequency (LF) 134.2-kHz Texas Instruments transponders. In combination with a reader/writer, they transmit energy and signals to the transponder and receive the response from the tag. There are two standard gate antennas and two standard stick antennas with 1-meter or 3-meter cable length. Each antenna generates a specific size and shape of read zone to meet the requirements of the target application. In general, the gate antennas generate a large read zone with greater distance, while the stick antennas provide a more focused read zone and an ability to discriminate between transponders.

The antennas are well suited for use in a broad range of applications including access control, vehicle identification, container tracking, asset management, and waste management applications.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

## Gate Antennas – Specifications

### Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)

	RI-ANT-G01E	RI-ANT-G02E	UNIT
Operating Temperature	–30 to +60	–30 to +60	°C
Storage Temperature	–40 to +70	–40 to +70	°C

### Operating Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER	RI-ANT-G01E	RI-ANT-G02E	UNIT
Inductance (typical), at 134.2 kHz	27	27	μH
Protection Class	IP 65	IP 65	
Vibration	Mil-Std-810E, Test 514.4 (Category 1, Procedure 1; Basic transportation)		
Case Material	UVSHIPS (UV-Stabilized High Impact Polystyrol)		
Dimensions	715 ± 5 × 270 ± 3 × 25 ± 1	200 ± 3 × 200 ± 3 × 25 ± 1	mm
Weight (typical)	745	425	g
Cable Length	1	1	m
Connection Terminals	Spade and tongue, stud hole 3.5 mm, width 7.5 mm		
Mounting	Use nonmetallic clamps, standard screws, and washers through 6.5-mm predrilled holes, so that the screw hole is flush with the mounting. Mounting material is not supplied with the antenna.		

## Stick Antennas – Specifications

### Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)

	RI-ANT-S01C	RI-ANT-S02C	UNIT
Operating Temperature	–30 to +70	–30 to +70	°C
Storage Temperature	–40 to +85	–40 to +85	°C

### Operating Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER	RI-ANT-S01C	RI-ANT-S02C	UNIT
Inductance (typical), at 134.2 kHz	27	27	μH
Protection Class	IP 66	IP 66	
Vibration	Mil-Std-810E, Test 514.4 (Category 1, Procedure 1; Basic transportation)		
Case Material	Glass reinforced epoxy (gray)		
Dimensions	140 ± 2 × 21 ± 2 (dia.)	140 ± 2 × 21 ± 2 (dia.)	mm
Weight (typical)	134	185	g
Cable Length	1	3	m
Connection Terminals	Ring lugs: 3.5-mm inside diameter 7.5-mm outside diameter	Ring lugs: 3.5-mm inside diameter 7.5-mm outside diameter	
Mounting	Use nonmetal clamps. Mounting material is not supplied with the antenna.		

### Readout Pattern of Ferrite Rod (Stick) and Gate Antennas

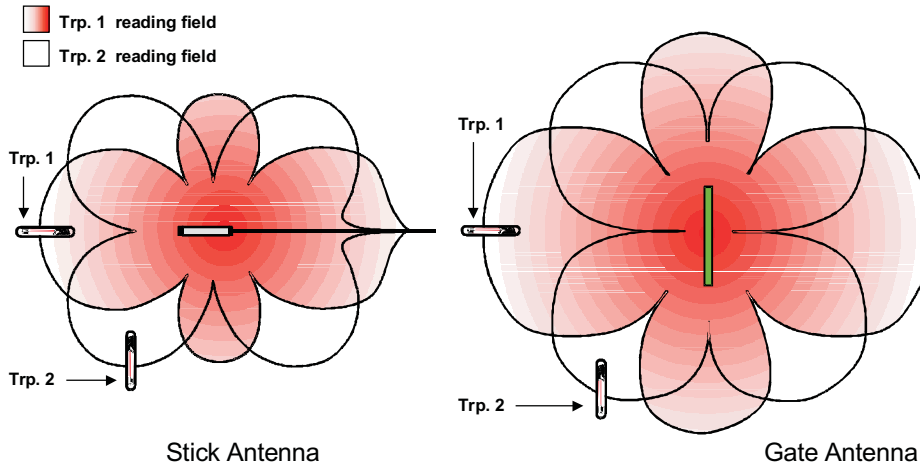


Figure 1. Readout Pattern of Antennas

## REVISION HISTORY

REVISION	CHANGES
SCBS845	First release
SCBS845A	Removed all information about RI-ANT-G04E and RI-ANT-P02A (obsolete)

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
RI-ANT-G01E-30	ACTIVE			0	1	TBD	Call TI	Call TI	-30 to 60		<a href="#">Samples</a>
RI-ANT-G02E-30	ACTIVE			0	1	TBD	Call TI	Call TI	-30 to 60		<a href="#">Samples</a>
RI-ANT-S02C-30	ACTIVE			0	1	TBD	Call TI	Call TI	-30 to 70		<a href="#">Samples</a>
TRPGP40TGC	ACTIVE	RFIDT	TGC	0		TBD	Call TI	Call TI	-25 to 70		<a href="#">Samples</a>
TRPGR30ATGA	ACTIVE	RFIDT	TGA	0	2000	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	-25 to 70		<a href="#">Samples</a>
TRPGR30ATGB	ACTIVE	RFIDT	TGB	0	2000	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	-25 to 70		<a href="#">Samples</a>
TRPGR30ENATGA	ACTIVE	RFIDT	TGA	0	2000	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	-25 to 70		<a href="#">Samples</a>
TRPGR30ENATGB	ACTIVE	RFIDT	TGB	0	2000	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	-25 to 70		<a href="#">Samples</a>
TRPGR30TGC	ACTIVE	RFIDT	TGC	0		TBD	Call TI	Call TI	-25 to 85		<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

### Products

Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
OMAP Applications Processors	<a href="http://www.ti.com/omap">www.ti.com/omap</a>
Wireless Connectivity	<a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a>

### Applications

Automotive and Transportation	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
Communications and Telecom	<a href="http://www.ti.com/communications">www.ti.com/communications</a>
Computers and Peripherals	<a href="http://www.ti.com/computers">www.ti.com/computers</a>
Consumer Electronics	<a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>
Energy and Lighting	<a href="http://www.ti.com/energy">www.ti.com/energy</a>
Industrial	<a href="http://www.ti.com/industrial">www.ti.com/industrial</a>
Medical	<a href="http://www.ti.com/medical">www.ti.com/medical</a>
Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
Space, Avionics and Defense	<a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a>
Video and Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>

### TI E2E Community

[e2e.ti.com](http://e2e.ti.com)